Presettable Counters

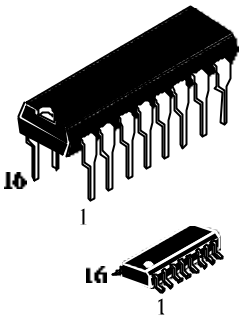
High-Performance Silicon-Gate CMOS

The SL74HC163 is identical in pinout to the LS/ALS163. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LS/ALSTTL outputs.

The SL74HC163 is programmable 4-bit synchronous counter that feature parallel Load, synchronous Reset, a Carry Output for cascading and count-enable controls.

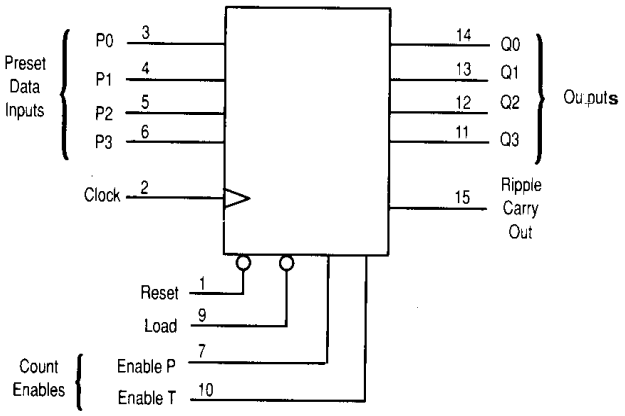
The SL74HC163 is binary counter with synchronous Reset.

- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2.0 to 6.0 V
- Low Input Current: 1.0 μA
- High Noise Immunity Characteristic of CMOS Devices



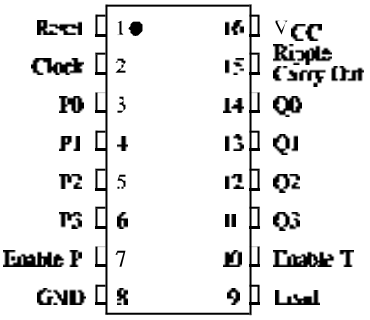
ORDERING INFORMATION
SL74HC163N Plastic
SL74HC163D SOIC
T_A = -55° to 125° C for all packages

LOGIC DIAGRAM



PIN 16 =V_{CC}
PIN 8 = GND

PIN ASSIGNMENT



FUNCTION TABLE

Inputs					Outputs				
Reset	Load	Enable P	Enable T	Clock	Q0	Q1	Q2	Q3	Function
L	X	X	X	⎍	L	L	L	L	Reset to “0”
H	L	X	X	⎍	P0	P1	P2	P3	Preset Data
H	H	X	L	⎍	No change				No count
H	H	L	X	⎍	No change				No count
H	H	H	H	⎍	Count up				Count
X	X	X	X	⎎	No change				No count

X=don’ t care
P0,P1,P2,P3 = logic level of Data inputs
Ripple Carry Out = Enable T • Q0 • Q1 • Q2 • Q3

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit
V_{CC}	DC Supply Voltage (Referenced to GND)	-0.5 to +7.0	V
V_{IN}	DC Input Voltage (Referenced to GND)	-1.5 to V_{CC} +1.5	V
V_{OUT}	DC Output Voltage (Referenced to GND)	-0.5 to V_{CC} +0.5	V
I_{IN}	DC Input Current, per Pin	±20	mA
I_{OUT}	DC Output Current, per Pin	±25	mA
I_{CC}	DC Supply Current, V_{CC} and GND Pins	±50	mA
P_D	Power Dissipation in Still Air, Plastic DIP+ SOIC Package+	750 500	mW
Tstg	Storage Temperature	-65 to +150	°C
T_L	Lead Temperature, 1 mm from Case for 10 Seconds (Plastic DIP or SOIC Package)	260	°C

*Maximum Ratings are those values beyond which damage to the device may occur.
Functional operation should be restricted to the Recommended Operating Conditions.
+Derating - Plastic DIP: - 10 mW/°C from 65° to 125°C
SOIC Package: : - 7 mW/°C from 65° to 125°C

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Max	Unit
V_{CC}	DC Supply Voltage (Referenced to GND)		2.0	6.0	V
V_{IN}, V_{OUT}	DC Input Voltage, Output Voltage (Referenced to GND)		0	V_{CC}	V
T_A	Operating Temperature, All Package Types		-55	+125	°C
t_r, t_f	Input Rise and Fall Time (Figure 1)	V_{CC} =2.0 V V_{CC} =4.5 V V_{CC} =6.0 V	0 0 0	1000 500 400	ns

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{IN} and V_{OUT} should be constrained to the range GND≤(V_{IN} or V_{OUT})≤V_{CC}.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

DC ELECTRICAL CHARACTERISTICS(Voltages Referenced to GND)

Symbol	Parameter	Test Conditions	V_{CC} V	Guaranteed Limit			Unit
				25 °C to -55°C	≤85 °C	≤125 °C	
V_{IH}	Minimum High-Level Input Voltage	V_{OUT}=0.1 V or V_{CC}-0.1 V $\|I_{OUT}\| \leq 20\ \mu A$	2.0 4.5 6.0	1.5 3.15 4.2	1.5 3.15 4.2	1.5 3.15 4.2	V
V_{IL}	Maximum Low -Level Input Voltage	V_{OUT}=0.1 V or V_{CC}-0.1 V $\|I_{OUT}\| \leq 20\ \mu A$	2.0 4.5 6.0	0.5 1.35 1.8	0.5 1.35 1.8	0.5 1.35 1.8	V
V_{OH}	Minimum High-Level Output Voltage	V_{IN}=V_{IH} or V_{IL} $\|I_{OUT}\| \leq 20\ \mu A$	2.0 4.5 6.0	1.9 4.4 5.9	1.9 4.4 5.9	1.9 4.4 5.9	V
		V_{IN}=V_{IH} or V_{IL} $\|I_{OUT}\| \leq 6.0$ mA $\|I_{OUT}\| \leq 7.8$ mA	 4.5 6.0	 3.98 5.48	 3.84 5.34	 3.7 5.2	
V_{OL}	Maximum Low-Level Output Voltage	V_{IN}=V_{IH} or V_{IL} $\|I_{OUT}\| \leq 20\ \mu A$	2.0 4.5 6.0	0.1 0.1 0.1	0.1 0.1 0.1	0.1 0.1 0.1	V
		V_{IN}=V_{IH} or V_{IL} $\|I_{OUT}\| \leq 6.0$ mA $\|I_{OUT}\| \leq 7.8$ mA	 4.5 6.0	 0.26 0.26	 0.33 0.33	 0.4 0.4	
I_{IN}	Maximum Input Leakage Current	V_{IN}=V_{CC} or GND	6.0	±0.1	±1.0	±1.0	μA
I_{CC}	Maximum Quiescent Supply Current (per Package)	V_{IN}=V_{CC} or GND I_{OUT}=0μA	6.0	4.0	40	160	μA

AC ELECTRICAL CHARACTERISTICS (C_L=50pF,Input t_r=t_f=6.0 ns)

Symbol	Parameter	V_{CC} V	Guaranteed Limit			Unit
			25 °C to -55°C	≤85°C	≤125°C	
f_{max}	Maximum Clock Frequency (Figures1,6)	2.0 4.5 6.0	6 30 35	5 24 28	4 20 24	MHz
t_{PLH}	Maximum Propagation Delay Clock to Q (Figures 1,6)	2.0 4.5 6.0	120 20 16	160 23 20	200 28 22	ns
t_{PHL}		2.0 4.5 6.0	145 22 18	185 25 20	320 30 23	ns
t_{PLH}	Maximum Propagation Delay Enable T to Ripple Carry Out (Figures 2,6)	2.0 4.5 6.0	110 16 14	150 18 15	190 20 17	ns
t_{PHL}		2.0 4.5 6.0	135 18 15	175 20 16	210 22 20	ns
t_{PLH}	Maximum Propagation Delay Clock to Ripple Carry Out (Figures 1,6)	2.0 4.5 6.0	120 22 18	160 27 22	200 30 25	ns
t_{PHL}		2.0 4.5 6.0	145 22 20	185 28 24	220 35 28	ns
t_{TLH}, t_{THL}	Maximum Output Transition Time, Any Output, (Figures 1 and 6)	2.0 4.5 6.0	75 15 13	95 19 16	110 22 19	ns
C_{IN}	Maximum Input Capacitance	-	10	10	10	pF

C_{PD}	Power Dissipation Capacitance (Per Gate) Used to determine the no-load dynamic power consumption: $P_D=C_{PD}V_{CC}^2f+I_{CC}V_{CC}$	Typical @25°C,V_{CC}=5.0 V 30	pF

TIMING REQUIREMENTS (C_L=50pF,Input t_r=t_f=6.0 ns)

Symbol	Parameter	V_{CC} V	Guaranteed Limit			Unit
			25 °C to -55°C	≤85°C	≤125°C	
t_{su}	Minimum Setup Time, Preset Data Inputs to Clock (Figure 4)	2.0 4.5 6.0	40 15 12	60 20 18	80 30 20	ns
t_{su}	Minimum Setup Time, Load to Clock (Figure 4)	2.0 4.5 6.0	60 15 12	75 20 18	90 30 20	ns
t_{su}	Minimum Setup Time, Reset to Clock (Figure 3)	2.0 4.5 6.0	60 20 17	75 25 23	90 35 25	ns
t_{su}	Minimum Setup Time, Enable T or Enable P to Clock (Figure 5)	2.0 4.5 6.0	80 20 17	95 25 23	110 35 25	ns
t_h	Minimum Hold Time, Clock to Load or Preset Data Inputs (Figure 4)	2.0 4.5 6.0	3 3 3	3 3 3	3 3 3	ns
t_h	Minimum Hold Time, Clock to Reset (Figure 3)	2.0 4.5 6.0	3 3 3	3 3 3	3 3 3	ns
t_h	Minimum Hold Time, Clock to Enable T or Enable P (Figure 5)	2.0 4.5 6.0	3 3 3	3 3 3	3 3 3	ns
t_{rec}	Minimum Recovery Time, Load Inactive to Clock (Figure 4)	2.0 4.5 6.0	80 15 12	95 20 17	110 26 23	ns
t_w	Minimum Pulse Width, Clock (Figure 1)	2.0 4.5 6.0	60 12 10	75 15 13	90 18 15	ns
t_w	Minimum Pulse Width, Reset (Figure 3)	2.0 4.5 6.0	60 12 10	75 15 13	90 18 15	ns
t_r, t_f	Maximum Input Rise and Fall Times (Figure 1)	2.0 4.5 6.0	1000 500 400	1000 500 400	1000 500 400	ns

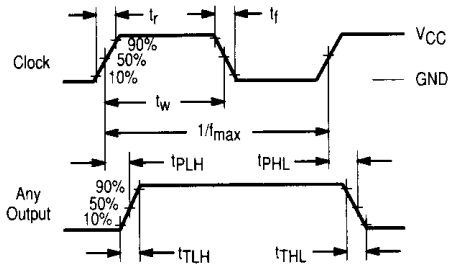


Figure 1. Switching Waveforms

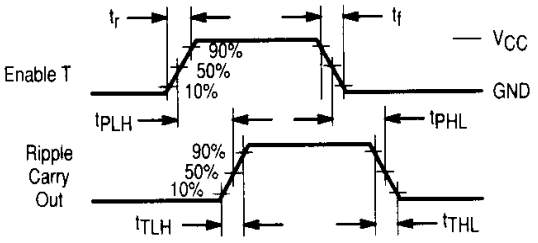


Figure 2. Switching Waveforms

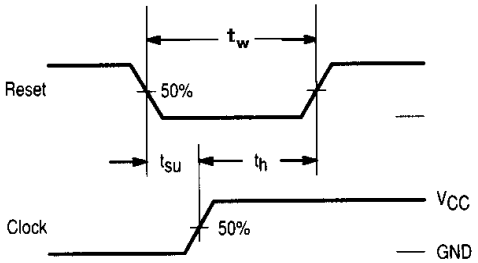


Figure 3. Switching Waveforms

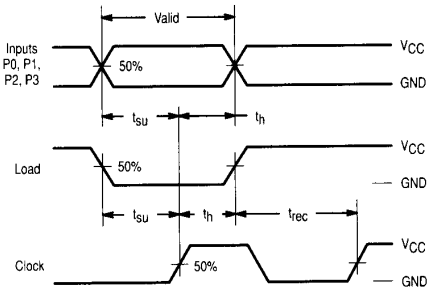


Figure 4. Switching Waveforms

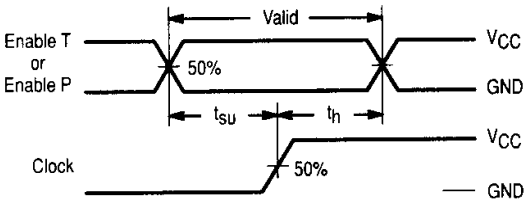


Figure 5. Switching Waveforms

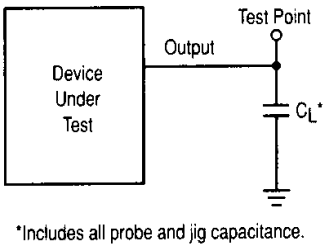
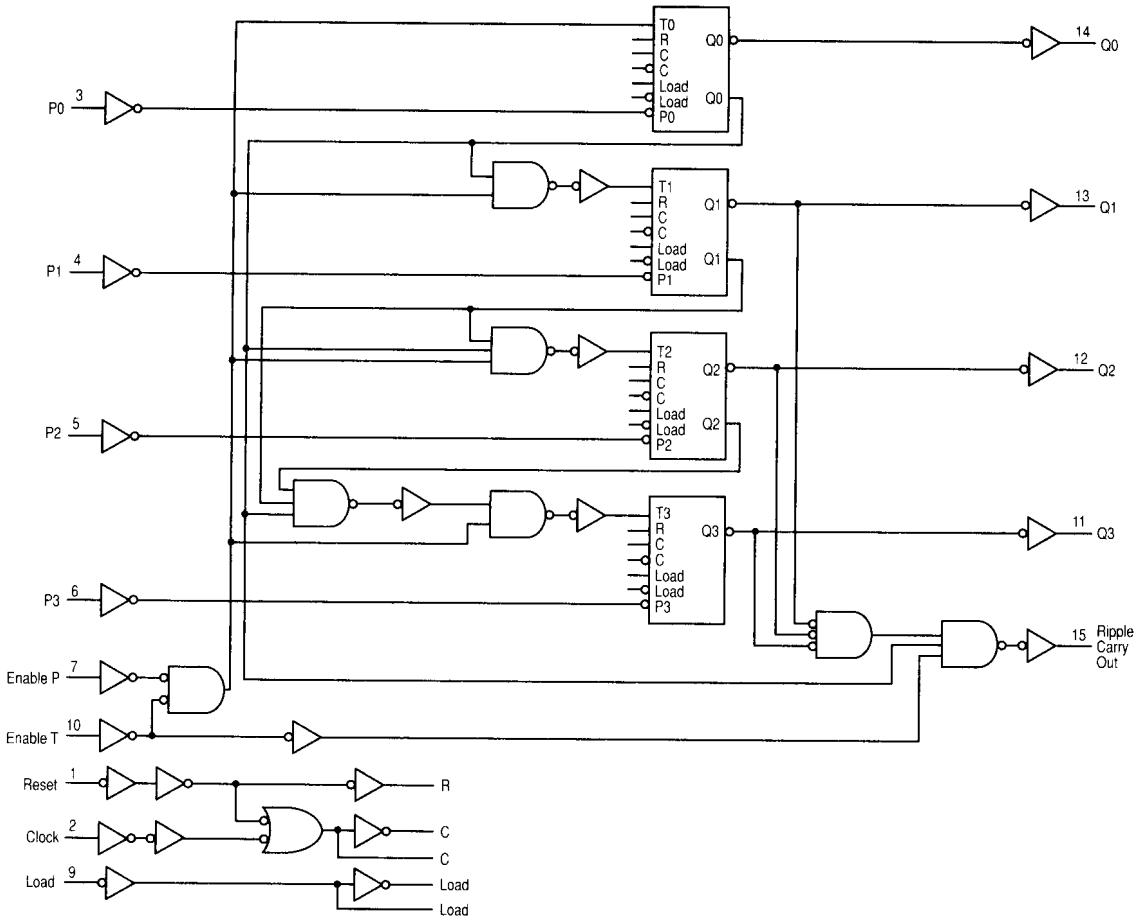


Figure 6. Test Circuit

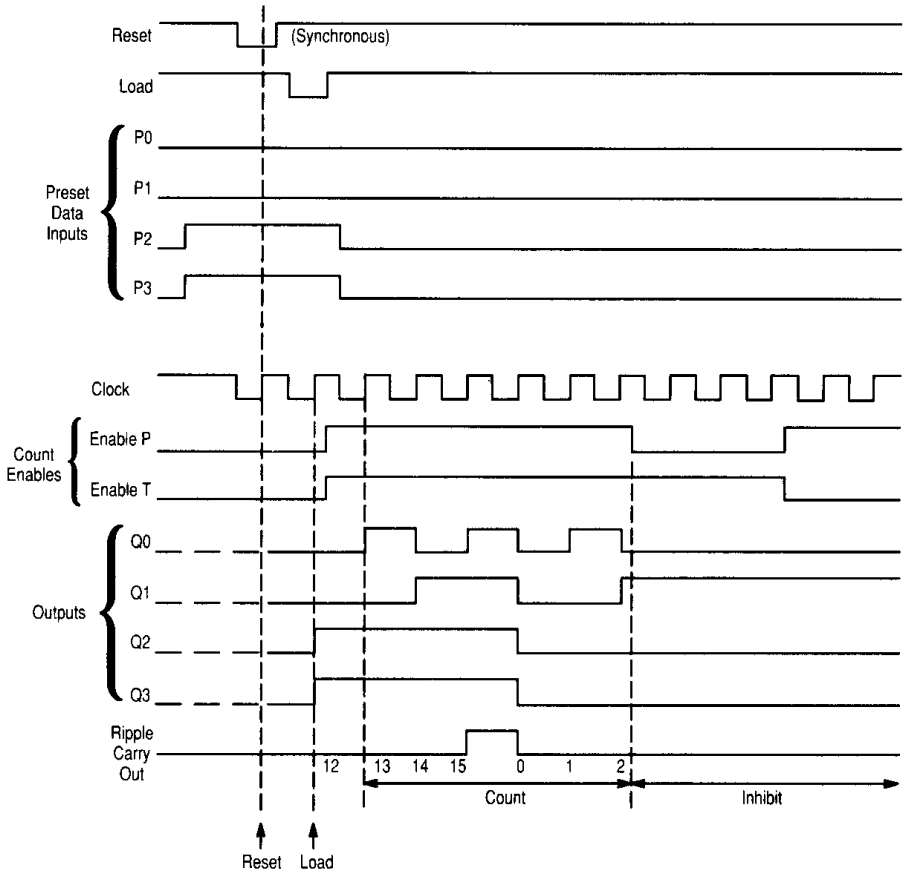


V_{CC}=Pin 16
GND=Pin 8

The flip-flops shown in the circuit diagrams are Toggle-Enable flip-flops. A Toggle-Enable flip-flop is a combination of a D flip-flop and a T flip-flop. When loading data from Preset inputs P0, P1, P2, and P3, the Load signal is used to disable the Toggle input (Tn) of the flip-flop. The logic level at the Pn input is then clocked to the Q output of the flip-flop on the next rising edge of the clock.

A logic zero on the Reset device input forces the internal clock (C) high and resets the Q output of the flip-flop low.

Figure 7.Expanded logic diagram

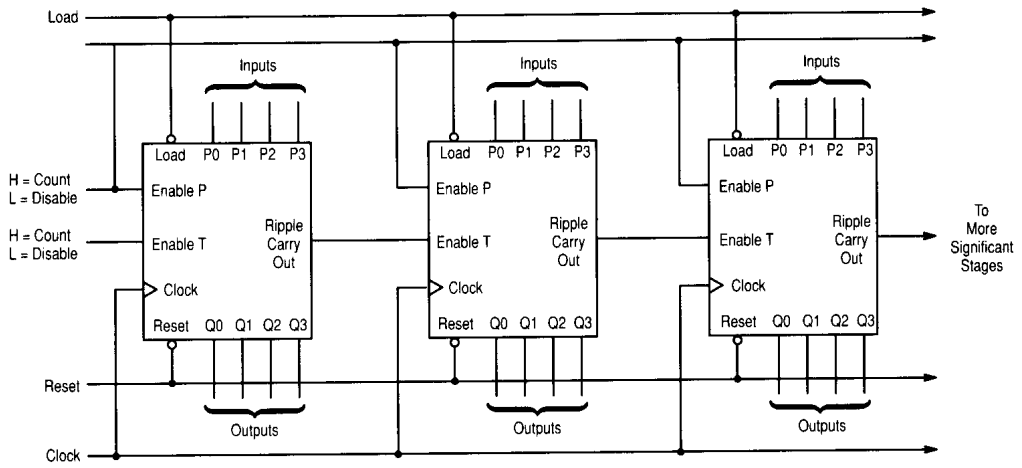


Sequence illustrated in waveforms:

1. Reset outputs to zero.
2. Preset to binary twelve.
3. Count to thirteen, fourteen, fifteen, zero, one, and two.
4. Inhibit.

Figure 8. Timing Diagram

TYPICAL APPLICATIONS CASCADING



Note: When used in these cascaded configurations the clock f_{max} guaranteed limits may not apply. Actual performance will depend on number of stages. This limitation is due to set up times between Enable (Port) and clock.

Figure 9. N-Bit Synchronous Counters

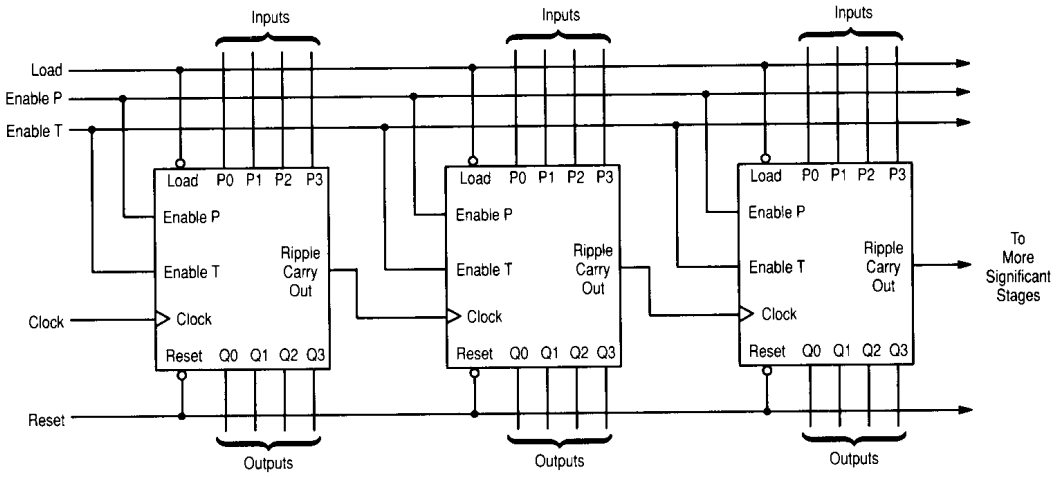


Figure 10. Nibble Ripple Counter